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(to be use	d for all correspondence afte	erinitial filing)	Group Art Unit	3752
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Total Number	of Pages in This Submis	sion 14 pages + 113 refs.	Attorney Docket Numb	per 51454 2001000
			URES (check all	that apply)
Fee Transm	ittal Form	Assignment	Papers	After Allowance Commu
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Amendmen	t/Reply	Licensing-rel	ated Papers	Appeal Communication to (Appeal Notice, Brief, Reply to
After	Final	Petition		Proprietary Information
Affida	vits/declaration(s)	Petition to Co	onvert to a Provisional	Status Letter
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Signature	Johney U. Han - 45	· (
Date	June 25, 2003	th	-	
	Julie 23, 2000			

I hereby certify that this correspondence is being deposit with the U.S. Postal Service as Express Mail, Airbill No. EV 333857341 US, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.

S Jull

PATENT Docket No. **51454**2001000

JUN 2 5 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

(Tamara Alcaraz)

In the application of:

Signature:

Roger O. WILLIAMS, et al

Serial No.: 10/

10/006,489

Filing Date:

December 6, 2001

For:

APPARATUS AND METHOD FOR

DROPLET STEERING

Examiner: Not Yet Assigned

Group Art Unit: 3752

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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. § 1.97 AND § 1.98

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 RECEIVED

JUL 0 1 2003

TECHNOLOGY CENTER R3700

Dear Sir:

Pursuant to 37 C.F.R. § 1.97 and § 1.98, Applicants submit for consideration in the above-identified application the documents listed on the attached Form PTO-1449. Copies of the documents are also submitted herewith. The Examiner is requested to make these documents of record.

This Supplemental Information Disclosure Statement is submitted: \boxtimes Within three months of the application filing date or before mailing of a first Office Action on the merits; accordingly, no fee or separate requirements are required. After receipt of a first Office Action on the merits but before mailing of a final Office Action or Notice of Allowance. A fee is required. A check in the amount of is enclosed. A fee is required. Accordingly, a Fee Transmittal form (PTO/SB/17) is attached to this submission in duplicate. A Certification under 37 C.F.R. § 1.97(e) is provided below; accordingly; no fee is believed to be due. After mailing of a final Office Action or Notice of Allowance, but before payment of the issue fee. A Certification under 37 C.F.R. § 1.97(e) is provided below and a check in the amount of is enclosed. A Certification under 37 C.F.R. § 1.97(e) is provided below and a Fee П

Applicants would appreciate the Examiner initialing and returning the Form PTO-1449, indicating that the information has been considered and made of record herein.

Transmittal form (PTO/SB/17 is attached to this submission in duplicate.

The information contained in this Supplemental Information Disclosure Statement under 37 C.F.R. § 1.97 and § 1.98 is not to be construed as a representation that: (i) a complete search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the above information constitutes prior art to the subject invention.

In the unlikely event that the transmittal letter is separated from this document and the Patent Office determines that an extension and/or other relief is required, Applicants petition for any required relief including extensions of time and authorize the Assistant Commissioner to charge the cost of such petitions and/or other fees due in connection with the filing of this document to **Deposit Account No. 03-1952** referencing <u>514542001000</u>. However, the Assistant Commissioner is not authorized to charge the cost of the issue fee to the Deposit Account.

Dated: June 25, 2003

Respectfully submitted,

By

Johney Han

Registration No. 45,565

Morrison & Foerster LLP 755 Page Mill Road

Palo Alto, California 94304-1018

Telephone: (650) 813-5786 Facsimile: (650) 494-0792

Form Par Gal A49

INFORMATION DISCLOSURE CITATION IN AN APPLICATION

(Use several sheets if necessary)

Docket Number 514542001000	Application Number 10/006,489
Applicant	
Roger O	. WILLIAMS, et al
Filing Date December 6, 2001	Group Art Unit 3752
Mailing Date June 25, 2003	

U.S. PATENT DOCUMENTS

Examiner Initials	Ref. No.	Date	Document No.	Name	Class	Subclass	Filing Date If Appropriate
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EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if citation considered, whether or not the citation conforms with MPEP 609. Draw a line through the citation if not in conformance and not considered. Include a copy of this form with next communication to applicant.

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INFORMATION DISCLOSURE CITATION IN AN APPLICATION

(Use several sheets if necessary)

	Sheet 2 of 3
Docket Number 514542001000	Application Number 10/006,489
Applicant	
Roger O	. WILLIAMS, et al
Filing Date December 6, 2001	Group Art Unit 3752

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DATE CONSIDERED:

EXAMINER: Initial if citation considered, whether or not the citation conforms with MPEP 609. Draw a line through the citation if not in conformance and not considered. Include a copy of this form with next communication to applicant.

INFORMATION DISCLOSURE CITATION IN AN APPLICATION

Docket Number 514542001000 Application Number 10/006,489 Applicant Roger O. WILLIAMS, et al

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Korm PTC	1 449			Docket Number 514	542001000	Application	on Number 10/006,489	
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			Mailing Date June 25	5, 2003				
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